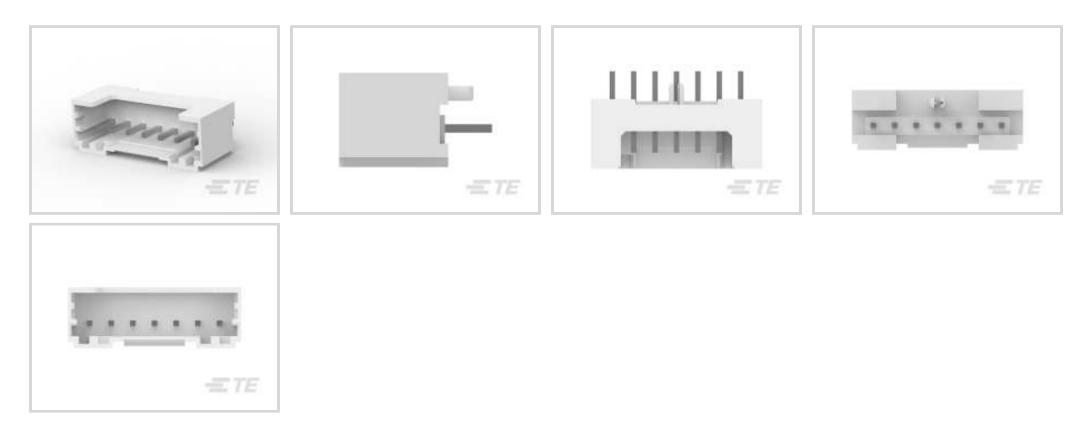


GRACE INERTIA 2.0

TE Internal #: 1971032-7 PCB Mount Header, Vertical, Wire-to-Board, 7 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.0

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 7

Number of Rows: 1

Centerline (Pitch): 2 mm [.079 in]

PCB Mount Orientation: Vertical

Features

TE

Product Type Features

Connector System	Wire-to-Board			
Header Type	Fully Shrouded			
Sealable	No			
Connector & Contact Terminates To	Printed Circuit Board			
PCB Connector Assembly Type	PCB Mount Header			
Configuration Features				
Number of Positions	7			
Number of Rows	1			
PCB Mount Orientation	Vertical			
Electrical Characteristics				
Operating Voltage	50 VAC			
Body Features				
Connector & Keying Code	A			
Primary Product Color	Natural			

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Contact Features

Mating Square Post Dimension	.5 mm[.02 in]
PCB Contact Termination Area Plating Material Thickness	2 μm[78.74 μin]
Contact Layout	Inline
Mating Tab Width	.5 mm[.02 in]
Contact Underplating Material Thickness	1 μm[39.37 μin]
Contact Mating Area Plating Material Thickness	2 μm[78.74 μin]
PCB Contact Termination Area Plating Material Finish	Bright
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Bright
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Tin
Contact Type	Tab
Contact Current Rating (Max)	2.2 A

Termination Features

Square Termination Post & Tail Dimension	.5 mm[.02 in]
Termination Post & Tail Length	2.6 mm[.102 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
PCB Mount Alignment Type	Locating Posts
Mating Alignment Type	Keyed
Mating Retention	With
Mating Retention Type	Latch
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	With
PCB Mount Retention	Without
Housing Features	
Housing Material	Nylon 6/6 GF
Centerline (Pitch)	2 mm[.079 in]

PCB Mount Header, Vertical, Wire-to-Board, 7 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.0



Dimensions

Connector Length	22 mm[.866 in]	
Connector Height	6.35 mm[.25 in]	
Connector Width	5.6 mm[.22 in]	
PCB Thickness (Recommended)	1.6 mm[.063 in]	
Usage Conditions		
Operating Temperature Range	-30 – 105 °C[-22 – 221 °F]	
Operation/Application		
Circuit Application	Signal	
Industry Standards		
Glow Wire Rating	Standard Part - Not Glow Wire	
Agency/Standard	UL	
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	200	
Packaging Type	Package	

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products

PCB Mount Header, Vertical, Wire-to-Board, 7 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.0



will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



2.0 EV



Also in the Series | GRACE INERTIA 2.0

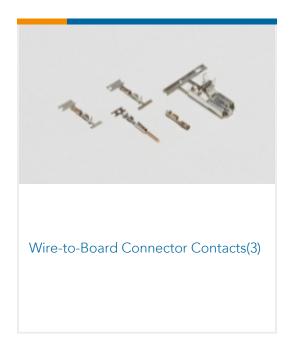
2.0 EV



2.0 EV

PCB Mount Header, Vertical, Wire-to-Board, 7 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.0





Customers Also Bought



TE Part #281484 MINI LEAF CONN ASSY

Documents

Product Drawings

7pos header assembly for gic 2.0 ev

English

7pos header assembly for gic 2.0 ev

English

CAD Files

3D PDF

3D

PCB Mount Header, Vertical, Wire-to-Board, 7 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.0



Customer View Model

ENG_CVM_CVM_1971032-7_D.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1971032-7_D.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1971032-7_D.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Application Specification

English

Product Environmental Compliance MD_1971032-7_03202019639_dmtec

English

MD_1971032-7_03202019639_dmtec

English